

Meeting Minutes: IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet Task Force

May 13 & 14, 2026
In-Person w/Remote Access Interim, Munich DE
(IEEE 802.3 Interim Meeting Series)

Prepared by George Zimmerman

See Appendix A for Attendance

IEEE P802.3dm Task Force meeting convened at **8:03 AM CEST, Wednesday, May 13, 2026**, by Natalie Wienckowski, IEEE P802.3dm Task Force Chair.

ALL TIMES ARE IN CEST.

Ms. Wienckowski turned to presentation [agenda_3dm_01a_051326.pdf](#) and reviewed the agenda for the meeting.

Presentation: https://www.ieee802.org/3/dm/public/0526/agenda_3dm_01a_0526.pdf

Presenter: Natalie Wienckowski, Chair

(NOTE – the presentation “agenda_3dm_01a_051326.pdf” or updates will be referred to as “the agenda deck” in these minutes.)

Approval of Agenda: The chair asked whether there were additions or corrections to the agenda, shown on slide 2 of the presentation [agenda_3dm_01a_051326.pdf](#). She then asked if there were any objections to approving the agenda.

A participant asked regarding where motions may be considered on the agenda. There was some discussion, clarifying that motions may be made from the floor, and could be delayed if they were approved.

MOTION #1:

Move to amend the draft agenda displayed on slide 3 of agenda_3dm_01a_051326.pdf with the modification such that the presentation titled Further Considerations Regarding a 7.5 Gb/s Rate is heard prior to comment resolution.

M: Kamal Dalmia

S: Tony Schedl

(PROCEDURAL > 50%)

Discussion: questions of clarification were asked and answered.

There was objection to the motion so the motion was taken by DVL – **SEE APPENDIX B FOR ROLL CALL**

Y: 33 N: 20 A: 7

MOTION PASSES (8:31)

The Chair then modified the displayed agenda and asked whether there was any objection to approving the modified agenda. (NOTE – This resulted in [agenda_3dm_01b_051326.pdf](#) being the ‘agenda deck’) There were no objections. – **The modified agenda was declared approved.**

MOTION #2:

Approve the meeting minutes for the:

March 5 OOC Interim (

https://www.ieee802.org/3/dm/public/030526/minutes_3dm_030526.pdf),

March 2026 Plenary (https://www.ieee802.org/3/dm/public/0326/minutes_3dm_0326.pdf),

March 17 ad hoc

(https://www.ieee802.org/3/dm/public/adhoc/031726/Unconfirmed_minutes_3dm_031726.pdf), and

April 7&9 OOC Interim

(https://www.ieee802.org/3/dm/public/040726/Unconfirmed_minutes_3dm_040726_v2.pdf).

M: Ragnar Jonsson

S: Peter Jones

MOTION APPROVED WITHOUT OBJECTION.

(8:38AM)

The Chair then resumed the review of the agenda deck

Ms. Wienckowski noted that there should be no recording or photography without permission.

Ms. Wienckowski asked if anyone was attending from the press including those who would run a public blog on this meeting – there were no indications from the group. **(8:40 AM)**

The chair discussed decorum and processes for joining the queue using the conference tool.

The chair discussed the goals of the meeting, which were resolution of comments on the task force review draft 0d, create D2.0 for WG ballot, and progress the draft to the working group for consideration of initial Working Group Ballot.

Ms. Wienckowski then continued review of the presentation, reviewing information for the reflector, private area, and ground rules.

The Chair announced that under 802.3 rules, only working group voters may vote on motions, and that anyone in the meeting could vote in straw polls. In the agenda deck she provided a link to the IEEE 802.3 Ethernet Working Group Operations Manual for further information.

Attendance

The chair reminded the group that attendance would be taken from Webex, and she then reminded attendees that they should show their employer & affiliation, and how to set these to make them correct. **(8:47)**

IEEE Structure, Policies

Ms. Wienckowski continued review of the IEEE SA structure, where to find the bylaws, policies & procedures documents, and operations manuals which hierarchically govern IEEE SA, IEEE 802 LMSC, and IEEE 802.3 activities.

She also asked whether anyone in the room or online had not seen the various policy slides. There were no responses. She then proceeded to show the slides and read through them.

IEEE SA Patent Policy, Ms. Wienckowski reviewed the IEEE SA Patent Policy (slides 19-23 in the agenda deck). During this, she read aloud the IEEE SA patent policy from the agenda deck and made the call for patents on the slide labeled “Ways to Inform IEEE” (slide 21) **(8:49AM)**.

There was no response to the call for patents at **8:49 AM**.

She then showed and read aloud slide 3 of the patent policy and showed slide 4 of the patent policy.

Other IEEE Policies

Ms. Wienckowski showed and read aloud the slides on the IEEE SA copyright, Participant behavior (ethics), IEEE individual participation, and the fair and equitable consideration policies slide (slides 24-29)

– at this point the chair indicated that anyone who did not agree should leave the meeting, and noted that no one left the meeting.

She then read, the decorum policy, and the IEEE ethics contact information in the agenda deck (slides 30-31). **(8:54 AM)**

There were no questions.

Ms. Wienckowski reviewed the standards development process for IEEE 802.3 and where this Task Force is in that process.

LIAISONS

The chair noted that the Task Force had received no liaisons.

Task Force Documents

The chair displayed the links to the project documents and noted the objectives were updated at the March meeting.

There was no discussion.

PRESENTATION ON Further Considerations Regarding a 7.5 Gb/s Rate

Title: Further Considerations Regarding a 7.5 Gb/s Rate

URL: https://www.ieee802.org/3/dm/public/0526/schedl_gorshe_3dm_01b_0526.pdf (revised presentation)

Presenters: Steve Gorshe (Microchip), Tony Schedl (BMW)

Discussion: The presenters discussed a camera use case and a display use case for 7.5 Gb/s, and arguments in favor of a 7.5Gb/s rate to the specification.

Questions were asked and answered.

There was significant discussion on the presentation. There were questions relating to specific text for the proposal, which participants were told was under development. Some participants questioned the basis for technical statements, advantages, and complexity given in the presentation.

Following the discussion, the meeting recessed for the morning break **(10:00 AM)**

The Chair called the meeting back to order at **10:22 AM**.

COMMENT RESOLUTION

The chair then presented the Editor's report: **(10:22AM)**

Presentation: https://www.ieee802.org/3/dm/public/0526/wienckowski_3dm_01b_0526.pdf

Presenter: Natalie Wienckowski, Chair & Chief Editor

The Chair & Chief Editor noted that the displayed version (01b) was updated to refer to late comments submitted. The submitter of the late comments withdrew them, and may resubmit on initial Working Group ballot.

The chair began a discussion of comment resolution at **10:25 AM**.

Comment resolution detail may be found in the comment database at:

https://www.ieee802.org/3/dm/comments/D0pd/IEEE_P8023dm_D0pd_comments_final_responses.pdf.

As part of the comment resolution, the following presentation was displayed:

Presentation: Comment on delay constraints Clause 202.12 (Updated)

URL: https://www.ieee802.org/3/dm/public/0526/Chini-3dm_01c_0426.pdf

Authors: Ahmad Chini, Broadcom & Scott Muma, Microchip

Discussion: The presentation was shown in connection with resolution of comment #1.

10:33AM Comment resolution was completed.

MOTION #3:

Instruct the Editors to create D2.0 from D0.d and closed comments received on D0.d, with editorial license, including updating the Clause numbers.

Request that IEEE 802.3 Working Group progress the draft to Working Group Ballot.

M: George Zimmerman

S: Valerie Maguire

Technical (>= 75% required)

Discussion: There was substantial discussion regarding going to initial working group ballot prior to resolving the issue of adding 7.5 Gb/s. Other participants suggested that the feature could be added by comment during working group ballot, or even as late as SA ballot.

The chair asked whether there was any objection to the motion, and there was objection, so the motion was taken roll-call on DVL per the rules.

Y: 32 N: 16 A: 9 See Appendix C for roll call

MOTION FAILS

MOTION #4:

Instruct the Editors to create D0.e from D0.d and closed comments received on D0.d, with editorial license, including updating the Clause numbers.

M: Scott Muma

S: Kamal Dalmia

Technical (>= 75% Required)

MOTION PASSES BY VOICE WITHOUT OPPOSITION

(11:38 AM)

The chair reminded participants to log into IMAT and paused for participants to log in.

Presentation: Measurements on PoC Noise and Coupling

URL: https://www.ieee802.org/3/dm/public/0526/strohmeier_3dm_01b_0526.pdf

Authors: Heiko Strohmeier (Robert Bosch GmbH)

Discussion: The presenter discussed measurements he had made of noise induced by power coupling with a spread-spectrum PMIC on a camera module.

Questions were asked and answered.

12:09 PM

The chair advised participants to consider what might be needed to proceed to WG ballot, and noted that additional presentations would be heard Thursday at 8AM.

At 12:11 PM the meeting recessed to resume on Thursday 5/14 at 8:00 AM.

At 8:05 AM on 5/14 Ms. Wienckowski, the Chair, called the meeting to order.

The Chair asked if there were any members of the press present, there were no responses.

The Chair showed the patent policy slide (page 21) and made the call for patents. There were no responses.

The Chair showed the IEEE SA copyright, Participant behavior (ethics), IEEE individual participation, and the fair and equitable consideration policies slide (slides 24-29) – at this point the chair indicated that anyone who did not agree should leave the meeting, and noted that no one left the meeting.

(8:11 AM) Presentations resumed.

Presentation: Screening Attenuation, and Cross Talk Limit, Continued Discussion on Proposals

URL: https://www.ieee802.org/3/dm/public/0526/Boyer_Sharma_3dm_01_0526.pdf

Authors: Rich Boyer (Aptiv), and Rohit Sharma (Molex)

Discussion: The presenter discussed proposals for Screening Attenuation and Crosstalk limits building consensus for a proposed future comment. Questions were asked and answered.

Presentation: Impact of High Pass Filtering on ACT Test mode 4 SNDR measurements

URL: https://www.ieee802.org/3/dm/public/0526/sakuna_etal_3dm_01a_0526.pdf

Authors: Saket Sakunia, Wyant Chan, Ragnar Jonsson [Infineon]

Presenter: Ragnar Jonsson

Discussion: The presenter discussed issues seen in High Pass Filtering on ACT Test Mode 4 SNDR measurements to building consensus for a proposed future comment. He noted these issues are common to 802.3ch PHY specifications using Clause 104 powering. Questions were asked and answered.

Following a brief slido test, the following straw poll was offered:

Straw Poll #1

I am willing to support adding 7.5 Gb/s High-Speed rate capability to P802.3dm clause 192 (TDD) assuming appropriate comments are submitted against D2.0:

Y: 48 N: 4 A: 15

(See Appendix D for results)

Following the straw poll, a participant requested to hear the presentations on Working Group ballot prior to any motions. There was no objection.

Presentation: What to expect during WG ballot (02a)

URL: https://www.ieee802.org/3/dm/public/0526/wienckowski_3dm_02a_0526.pdf

Presenter: Natalie Wienckowski, IVN Solutions (Chair)

Discussion: The presenter provided an overview of working group ballot process. During discussion, the Working Group Chair provided the clarification that an objective was not a necessary precursor to adding text to the draft. Additional clarification was provided that while the presentation was intended to be helpful, the governing rules documents (802.3 ops manual (<https://www.ieee802.org/3/rules/index.html>), WG P&Ps, LMSC Ops Manual, LMSC P&Ps, (<https://www.ieee802.org/devdocs.shtml>) and superior IEEE SA documents (see agenda deck) prevail should there be any contradiction.

During discussion, the Chair noticed it was time for the morning break. The group recessed at **10:01 AM**. The Chair called the meeting back to order at **10:27AM**.

Discussion on the presentation continued.

MOTION #5

Move to request the IEEE 802.3 Working Group progress D2.0 to Working Group Ballot.

M: TJ Houck

S: Max Turner

Technical >= 75%

During discussion, several individuals who had previously opposed stated that clarifications on the process had satisfied their concerns.

Additionally, a participant requested that a second ad hoc be held prior to comment resolution to hear issues that may come in with ballot comments.

MOTION PASSED BY VOICE WITHOUT OPPOSITION.
(10:50 AM) (Room Count 83)

A participant requested we set future meeting dates prior to hearing the final presentations. There was no objection.

FUTURE MEETINGS

The Chair then announced future (electronic) meetings:

Ad hoc: June 2, D2.0 Comment preview (9:30-1:30 PM EDT)
June 16 – D2.0 Comment consensus building (9:30 – 1:30 EDT)
OOO Interims (D2.0 comment resolution, all 9:30am – 1:30 PM EDT):
Contingent July 7, July 21, and July 23

Presentations continued... **(11:03 AM)**

Presentation: Suggested areas to consider for Working Group Ballot review

URL: https://www.ieee802.org/3/dm/public/0526/wienckowski_etal_3dm_03_0526.pdf

Presenter: Natalie Wienckowski, IVN Solutions (Chair & Chief Editor)

Authors: Natalie Wienckowski (IVN Solutions), Valerie Maguire (Copperopolis/various), Scott Muma (Microchip), Alireza Razavi (Eliyan/Infineon)

Discussion: The presenter provided a summary of areas that commenters may wish to apply attention in their review on initial working group ballot.

There were no questions.

The meeting then moved to late presentations.

Presentation: Misinterpreting Vendor-Specific Bits in 802.3dm

URL: https://www.ieee802.org/3/dm/public/0526/Razavi_3dm_01_0526.pdf.pdf

Presenter: Alireza Razavi (Eliyan/Infineon)

Discussion: The presenter provided a discussion of a proposal for vendor-specific bit usage, to build consensus for initial working group ballot.

Questions were asked and answered.

Presentation: PCS Function Verification - Using Deterministic Test Modes

URL: https://www.ieee802.org/3/dm/public/0526/Razavi_3dm_02_0526.pdf.pdf

Presenter: Alireza Razavi (Eliyan/Infineon)

Discussion: The presenter provided a discussion of a proposal for test modes, to build consensus for initial working group ballot.

There were no questions.

The Chair returned to the agenda deck, and reviewed additional future meetings.

Future Meetings (Hybrids)

802.3dm will meet at the IEEE 802 Plenary in Montreal, the week of July 13-17, exact days to be announced on the reflector. Registration and payment of a fee is required.

The Chair reminded participants to sign into IMAT and paused, asking if there were any individuals needing assistance recording their attendance.

CLOSING

The Chair announced that having exhausted the agenda, the meeting was adjourned. **(11:34 AM)**

Appendix A: Attendees at the IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet Task Force Meeting, May 13-14, 2026

First Name	Last Name	Affiliation	May 13 Webex	May 13 IMAT	May 14 Webex	May 14 IMAT
Ramanjit	Ahuja	ON Semiconductor	X	X	X	X
Tim	Baggett	Microchip Technology, Inc.			X	X
Amir	Bar-Niv	Marvell	X	X	X	X
Bert	Bergner	TE Connectivity	X	X	X	X
rich	boyer	Aptiv Signal and Power Solutions	X	X	X	X
Michal	Brychta	Analog Devices Inc.	X	X	X	X
Karl	Budweiser	BMW AG; BMW Group	X	X	X	X
Xiaoyue	Cheng	Infineon Technologies	X	X	X	X
ahmad	Chini	Broadcom Corporation	X	X	X	X
Jay	Cordaro	Analog Devices	X	X	X	X
Shaoan	Dai	Infineon Technologies	X	X	X	X
Kamal	Dalmia	NXP Semiconductors	X	X		
Andras	de Koos	Microchip Technology Inc			X	X
Hormoz	Djahanshahi	Microchip Technology, Inc.	X	X	X	X
Curtis	Donahue	Rohde & Schwarz	X	X	X	X
Jonas	Edele	BMW AG; BMW Group	X	X	X	X
Daniel	Estrakh	Valens Semiconductor	X	X	X	X
Paul	Fuller	Infineon Technologies			X	X
Aravind	Ganesan	Texas Instruments Inc.	X	X	X	X
Martin	Glanzner	SEI Automotive Europe GmbH	X	X	X	
Sachin	Goel	NXP	X	X	X	X
Steve	Gorshe	Microchip Technology, Inc.	X	X	X	X
Ajeya	Gupta	General Motors Company	X	X	X	X
Mary Sue	Haydt	Microchip Technology, Inc.	X	X	X	X
Thomas	Hogenmueller	Robert Bosch GmbH	X	X	X	X
Daniel	Hopf	AUMOVIO Germany GmbH	X	X	X	X
TJ	Houck	Infineon Technologies	X	X	X	X
Guy	Hutchison	Aviva Links Inc; Aviva Links Inc.	X	X	X	X
Brad	Jeffries	Analog Devices Inc.	X	X	X	
Markus	Jochim	General Motors Company	X	X		
Chad	Jones	Cisco Systems, Inc.	X	X	X	X
Peter	Jones	Cisco Systems, Inc.	X	X	X	X
Ragnar	Jonsson	Marvell	X	X	X	X
Manabu	Kagami	Nagoya Institute of Technology (NITech)	X	X	X	X
Venkata	Kandarpa	NXP Semiconductors	X	X	X	X
Samay	Kapoor	Aviva Links Inc.	X	X	X	X

First Name	Last Name	Affiliation	May 13 Webex	May 13 IMAT	May 14 Webex	May 14 IMAT
Do Kyun	Kim	LG ELECTRONICS	X	X	X	X
Gyudong	Kim	Analog Devices	X	X	X	X
Mathias	Kleinwaechter	in-tech GmbH	X	X	X	X
Sophie	Laperche	CetraC		X	X	X
Ariel	Lasry	Qualcomm Technologies, Inc	X	X	X	X
Ching-Yen	Lee	Realtek Semiconductor Corp.	X	X	X	X
Dongjae	Lee	Realtek Semiconductor Corp.	X	X	X	X
Hoei	Lim	NXP Semiconductors	X	X	X	X
YK	Lin	Realtek Semiconductor Corp.	X	X	X	X
William	Lo	Axonne Inc.	X	X	X	X
Wei	Lou	Broadcom Corporation	X	X	X	X
Chao	Lu	BMW Group	X	X	X	X
Valerie	Maguire	Copperopolis (aff'l with CME Consulting, Microchip, and NXP)	X	X	X	X
Kirsten	Matheus	BMW Group	X	X		
Michael	Miskho	Analog Devices Inc.	X	X	X	X
Thomas	Mueller	Rosenberger	X	X	X	X
Scott	Muma	Microchip Technology, Inc.	X	X	X	X
Brian	Murray	Analog Devices Inc.	X	X	X	X
Yuya	Nagaoka	Murata Electronics	X		X	
Christian	Neulinger	MD Elektronik	X	X		
Tiaq	Ng	NXP Semiconductors	X	X	X	X
Debu	Pal	ON Semiconductor	X	X	X	X
Chunpo	Pan	Broadcom Corporation	X	X	X	X
Sujan	Pandey	Velinktech	X	X	X	X
Pusik	Park	Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI);	X	X	X	X
Neven	Pischl	Broadcom Corporation	X	X	X	X
Alireza	Razavi	Infineon Technologies	X	X	X	X
Michael	Reinhard	SEI Automotive Europe GmbH	X	X	X	X
Anton	Schedl	BMW Group	X	X	X	X
Stephan	Schreiner	Rosenberger	X	X		
Hossein	Sedarat	Ethernovia	X	X	X	X
Rohit	Sharma	Molex Incorporated	X	X	X	X
Kapil	Shrikhande	Upscale AI			X	
Heiko	Strohmeier	Robert Bosch GmbH	X	X	X	X
jingcong	Sun	Motorcomm Electronic Technology Co	X	X	X	X

First Name	Last Name	Affiliation	May 13 Webex	May 13 IMAT	May 14 Webex	May 14 IMAT
Yuxuan	Tan	Motorcomm	X	X	X	X
Ahmet	Tanc	NXP Semiconductors; NXP Semiconductors	X	X	X	X
Simon	Tanz	BMW AG; BMW Group	X	X	X	X
Mehmet	Tazebay	Broadcom Corporation	X	X	X	X
Geoff	Thompson	INDEPENDENT	X	X	X	X
Luisma	Torres	KD	X	X	X	X
Mike	Tu	Broadcom Corporation	X	X	X	X
Max	Turner	Ethernovia	X	X	X	X
Ashraf	Umar	Molex Incorporated	X	X	X	X
Kambiz	Vakilian	Broadcom Corporation	X	X	X	X
Paul	Vanderlaan	Panduit Corp.	X	X	X	X
Bob	Voss	Panduit Corp.	X	X	X	X
Frank, S.-S.	Wang	Realtek Semiconductor Corp.	X	X	X	X
Terry	Wei	Analog Devices Inc.	X	X	X	X
Brian	Welch				X	
Natalie	Wienckowski	IVN Solutions LLC; Ethernovia, Bosch	X	X	X	X
James	Withey	Fluke Corporation	X	X	X	X
Dance	Wu	Infineon Technologies	X	X	X	X
Conrad	Zerna	NXP Semiconductors	X	X	X	X
kan	zhang	Huawei Technologies Co., Ltd	X	X	X	X
Tingting	Zhang	Huawei Technologies Co., Ltd	X	X	X	X
Wei	Zhang	Huawei Technologies Co., Ltd	X	X	X	X
George	Zimmerman	CME Consulting/Analog Devices, APL Group, Cisco, Eliyan, Infineon, OnSemi, Sony	X	X	X	X

Appendix B: Roll Call results Motion #1

MOTION #1:

Move to amend the draft agenda displayed on slide 3 of agenda_3dm_01a_051326.pdf with the modification such that the presentation titled Further Considerations Regarding a 7.5 Gb/s Rate is heard prior to comment resolution.

M: Kamal Dalmia

S: Tony Schedl

(PROCEDURAL > 50%)

Y: 33 N: 20 A: 7

MOTION PASSES (8:31)

First Name	Last Name	Vote	Affiliation
Ramanjit	Ahuja	Yes	Onsemi
Amir	Bar-Niv	No	Infineon
Rich	Boyer	No	Aptiv
Michal	Brychta	No	Analog Devices
Xiaoyue	Cheng	No	Infineon
Ahmad	Chini	Yes	Broadcom
Shaoan	Dai	No	Infineon
Kamal	Dalmia	Yes	NXP
Hormoz	Djahanshahi	Yes	Microchip
Daniel	Estrakh	No	Valens
Aravind	Ganesan	No	TI
Sachin	Goel	Yes	NXP
Steven	Gorshe	Yes	Microchip
Ajeya	Gupta	Yes	GM
Thomas	Hogenmueller	No	Robert bosch
Tj	Houck	No	Infineon
Guy	Hutchison	Yes	NXP
Brad	Jeffries	Yes	ADI
Peter	Jones	Yes	Cisco
Ragnar	Jonsson	No	Infineon
Manabu	Kagami	Yes	NITech
Venkata	Kandarpa	Yes	NXP
Samay	Kapoor	Yes	NXP
Gyudong	Kim	No	LGE
Mathias	Kleinwaechter	Yes	in-tech
Ariel	Lasry	Abstain	Qualcomm
Ching-Yen	Lee	Yes	Realtek
Hoei	Lim	Yes	NXP
Yk	Lin	Yes	Realtek
William	Lo	No	Axonne
Wei	Lou	Yes	Broadcom

First Name	Last Name	Vote	Affiliation
Valerie	Maguire	Abstain	Copperopolis, aff'l w/ CME Consulting, Microchip, and NXP
Kirsten	Matheus	Yes	BMW
Michael	Miskho	No	ADI
Scott	Muma	Yes	Microchip
Brian	Murray	No	Analog Devices
Debajyoti	Pal	Yes	onsemi
Chunpo	Pan	Yes	Broadcom
Neven	Pischl	Yes	Broadcom
Alireza	Razavi	No	Eliyan
Michael	Reinhard	Abstain	SEI Automotive Europe GmbH
Anton	Schedl	Yes	BMW Group
Hossein	Sedarat	No	Ethernovia
Rohit	Sharma	No	Molex
Heiko	Strohmeier	Abstain	Bosch
Jingcong	Sun	Yes	motorcomm
Yuxuan	Tan	Abstain	Motorcomm
Ahmet	Tanc	Abstain	NXP
Mehmet	Tazebay	Yes	Broadcom
Geoff	Thompson	Abstain	GraCaSi-Ind
Mike	Tu	Yes	Broadcom
Max	Turner	No	Ethernovia
Kambiz	Vakilian	Yes	Broadcom
Shun-Sheng	Wang	Yes	Realtek
Terry	Wei	Yes	ADI
James	Withey	Yes	Fluke
Dance	Wu	No	Infineon
Conrad	Zerna	Yes	NXP
Wei	Zhang	Yes	CMCC
George	Zimmerman	No	CME Consulting/ADI, APL Gp, Cisco, Eliyan, Infineon, OnSemi, Sony

Appendix C: Roll Call results Motion #3

MOTION #3:

Instruct the Editors to create D2.0 from D0.d and closed comments received on D0.d, with editorial license, including updating the Clause numbers.

Request that IEEE 802.3 Working Group progress the draft to Working Group Ballot.

M: George Zimmerman

S: Valerie Maguire

Technical (>= 75% required)

Y: 32 N: 16 A: 9

MOTION FAILS

First Name	Last Name	Vote	Affiliation
Ramanjit	Ahuja	No	Onsemi
Amir	Bar-Niv	Yes	Infineon
Rich	Boyer	Yes	Aptiv
Michal	Brychta	Yes	Analog Devices
Ahmad	Chini	No	Broadcom
Shaoan	Dai	Yes	Infineon
Kamal	Dalmia	No	NXP
Hormoz	Djahanshahi	Yes	Microchip
Daniel	Estrakh	Abstain	Valens
Aravind	Ganesan	Abstain	TI
Sachin	Goel	No	NXP
Steven	Gorshe	Yes	Microchip
Ajeya	Gupta	Yes	GM
Thomas	Hogenmueller	Yes	Robert bosch
Tj	Houck	Yes	Infineon
Guy	Hutchison	Yes	NXP
Brad	Jeffries	Yes	ADI
Peter	Jones	Abstain	Cisco
Ragnar	Jonsson	Yes	Infineon
Venkata	Kandarpa	No	NXP
Gyudong	Kim	Yes	LGE
Mathias	Kleinwaechter	No	in-tech
Ariel	Lasry	Yes	Qualcomm
Ching-Yen	Lee	Yes	Realtek
Hoei	Lim	Yes	NXP
Yk	Lin	No	Realtek
William	Lo	Yes	Axonne
Wei	Lou	No	Broadcom
Valerie	Maguire	Yes	Copperopolis, aff'l w/ CME Consulting, Microchip, and NXP
Kirsten	Matheus	No	BMW

First Name	Last Name	Vote	Affiliation
Michael	Miskho	Yes	ADI
Scott	Muma	Yes	Microchip
Brian	Murray	Yes	Analog Devices
Hiok-Tiaq	Ng	No	NXP
Chunpo	Pan	No	Broadcom
Sujan	Pandey	Yes	Velinktech
Neven	Pischl	Abstain	Broadcom
Alireza	Razavi	Yes	Eliyan
Michael	Reinhard	Yes	SEI Automotive Europe GmbH
Anton	Schedl	No	BMW Group
Stephan	Schreiner	Abstain	Rosenberger
Hossein	Sedarat	Yes	Ethernovia
Rohit	Sharma	Yes	Molex
Heiko	Strohmeier	Yes	Bosch
Jingcong	Sun	Abstain	motorcomm
Yuxuan	Tan	Yes	Motorcomm
Mehmet	Tazebay	No	Broadcom
Geoff	Thompson	Abstain	GraCaSi-Ind
Luisma	Torres	No	KD
Mike	Tu	No	Broadcom
Max	Turner	Yes	Ethernovia
Shun-Sheng	Wang	Abstain	Realtek
James	Withey	Yes	Fluke
Dance	Wu	Yes	Infineon
Conrad	Zerna	Abstain	NXP
Wei	Zhang	No	CMCC
George	Zimmerman	Yes	CME Consulting/ADI, APL Gp, Cisco, Eliyan, Infineon, OnSemi, Sony

Appendix D: Roll Call results Straw Poll #1

Straw Poll #1

I am willing to support adding 7.5 Gb/s High-Speed rate capability to P802.3dm clause 192 (TDD) assuming appropriate comments are submitted against D2.0:

Y: 48 N: 4 A: 15

First Name	Last Name	Affiliation	Response
Ramanjit	Ahuja	Onsemi	Yes
Tim	Baggett	Microchip	Yes
Amir	Bar-Niv	Infineon	Yes
Bert	Bergner	TE Connectivity	Yes
rich	boyer	Aptiv	Yes
Michal	Brychta	Analog Devices	Abstain
ahmad	chini	Broadcom	Yes
Jay	Cordaro	Analog Devices	Yes
Andras	de Koos	Microchip	Yes
Hormoz	Djahanshahi	Microchip	Yes
Curtis	Donahue	Rohde & Schwarz	Abstain
Jonas	Edele	BMW	Yes
Daniel	Estrakh	Valens	No
Aravind	Ganesan	TI	Yes
Sachin	Goel	NXP	Yes
Steve	Gorshe	Microchip	Yes
Mary Sue	Haydt	Microchip	Yes
Thomas	Hogenmueller	Robert bosch	Yes
Daniel	Hopf	AUMOVIO	Yes
TJ	Houck	Infineon	Yes
Guy	Hutchison	NXP	Yes
Brad	Jeffries	ADI	Yes
Peter	Jones	Cisco	No
Manabu	Kagami	NITech	Abstain
Venkata	Kandarpa	NXP	Yes
DoKyun	Kim	LGE	Abstain
Gyudong	Kim	ADI	
Mathias	Kleinwaechter	in-tech	Yes
Ariel	Lasry	Qualcomm	Yes
Ching-Yen	Lee	Realtek	Yes
Hoei	Lim	NXP	Yes
YK	Lin	Realtek	Abstain
William	Lo	Axonne	Yes
Wei	Lou	Broadcom	Yes
Chao	Lu	BMW Group	

First Name	Last Name	Affiliation	Response
Valerie	Maguire	Copperopolis, aff'l w/ CME Consulting, Microchip, and NXP	Yes
Michael	Miskho	ADI	No
Thomas	Müller	Rosenberger	Abstain
Scott	Muma	Microchip	Yes
Brian	Murray	Analog Devices	Yes
Tiaq	Ng	NXP	Yes
Debu	Pal	onsemi	Yes
Chunpo	Pan	Broadcom	Yes
Sujan	Pandey	Velinktech	Yes
Pusik	Park	KETI	Yes
Fuller	Paul	#N/A	No
Neven	Pischl	Broadcom	Yes
Jonsson	Ragnar	#N/A	Yes
Alireza	Razavi	Eliyan	Yes
Anton	Schedl	BMW Group	Yes
Hossein	Sedarat	Ethernovia	Abstain
Dai	Shaoan	#N/A	Abstain
Heiko	Strohmeier	Bosch	Yes
jingcong	Sun	motorcomm	Abstain
Mehmet	Tazebay	Broadcom	Yes
Geoff	Thompson	GraCaSi-Ind	Abstain
Luisma	Torres	KD	Abstain
Max	Turner	Ethernovia	Abstain
Kambiz	Vakilian	Broadcom	Yes
Paul	Vanderlaan	Panduit	Abstain
Bob	Voss	Panduit	
Frank S.-S.	Wang	Realtek	Yes
Terry	Wei	ADI	Yes
Natalie	Wienckowski	IVN Solutions; Ethernovia, Bosch	
James	Withey	Fluke	Abstain
Dance	Wu	Infineon	Yes
Xiaoyue	Cheng	Infineon	Abstain
Conrad	Zerna	NXP	Yes
Wei	Zhang	CMCC	Yes
George	Zimmerman	CME Consulting/ADI, APL Gp, Cisco, Eliyan, Infineon, OnSemi, Sony	Yes
Anonymous		none	Yes